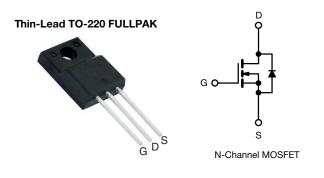
SiHA6N65E

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	700			
R _{DS(on)} max. (Ω) at 25 °C	$V_{GS} = 10 V$	0.6		
Q _g max. (nC)	48			
Q _{gs} (nC)	6			
Q _{gd} (nC)	11			
Configuration	Single			

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	Thin-Lead TO-220 FULLPAK
Lead (Pb)-free	SiHA6N65E-E3

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	650	V	
Gate-Source Voltage			V _{GS}	± 30	- V	
Continuous Drain Current (T _{.1} = 150 °C) ^e	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C	I.	7	A	
Continuous Drain Current $(1_j = 150 \text{ C})^{\circ}$	V _{GS} at 10 V	T _C = 100 °C	ID	5		
Pulsed Drain Current ^a	Drain Current ^a			18	1	
Linear Derating Factor				0.63	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	56	mJ	
Maximum Power Dissipation			PD	31	W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150	°C		
Drain-Source Voltage Slope	T _J = 1	125 °C	-I) / / -I+	37	1//20	
Reverse Diode dV/dt d			dV/dt	27	V/ns	
Soldering Recommendations (Peak temperature) ^c	For 10 s			300	°C	
Mounting Torque	M3 screw			0.6	Nm	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature. b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 2 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dI/dt = 100 A/µs, starting T_J = 25 °C. e. Limited by maximum junction temperature.

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COMPLIANT



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	43	65	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	3.1	4.0	0/10	

PARAMETER	SYMBOL	TES	TEST CONDITIONS			MAX.	UNIT		
Static									
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$		650	-	-	V		
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I _D = 1 mA		-	0.73	-	V/°C		
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		-	4	V		
Onto Onima Lagliana	I _{GSS}	$V_{GS} = \pm 20 V$		$V_{GS} = \pm 20 V$		-	-	± 100	nA
Gate-Source Leakage		١	$V_{\rm GS} = \pm 30 \text{ V}$	-	-	± 1	μA		
Zana Oata Malta na Duain Ourrant		V _{DS} =	V _{DS} = 650 V, V _{GS} = 0 V		-	1	•		
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 520 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA		
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 3 A	-	0.5	0.6	Ω		
Forward Transconductance	9 _{fs}	V _{DS} = 30 V, I _D = 3 A		-	2	-	S		
Dynamic		-		*	•	•	•		
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		410	820	1640	pF		
Output Capacitance	C _{oss}			20	40	80			
Reverse Transfer Capacitance	C _{rss}			2	4	8			
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V_{DS} = 0 V to 520 V, V_{GS} = 0 V		-	36	-			
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	117	-			
Total Gate Charge	Qg			-	24	48			
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	$V_{GS} = 10 \text{ V}$ $I_D = 3 \text{ A}, V_{DS} = 520 \text{ V}$		6	-	nC		
Gate-Drain Charge	Q _{gd}				11	-			
Turn-On Delay Time	t _{d(on)}	$V_{DD} = 520 \text{ V}, \text{ I}_{D} = 3 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	14	28	- ns		
Rise Time	t _r			-	12	24			
Turn-Off Delay Time	t _{d(off)}			-	30	60			
Fall Time	t _f			-	20	40			
Gate Input Resistance	Rg	f = 1 MHz, open drain		0.7	1.4	2.7	Ω		
Drain-Source Body Diode Characteristic									
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	7			
Pulsed Diode Forward Current	I _{SM}			-	-	18	A		
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 3 A, V _{GS} = 0 V		-	0.83	1.3	V		
Reverse Recovery Time	t _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 3 \text{ A},$ dI/dt = 100 A/µs ^{. V} _R = 25 V		118	237	474	ns		
Reverse Recovery Charge	Q _{rr}			-	2.2	-	μC		
Reverse Recovery Current	I _{RRM}			-	16	-	A		

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

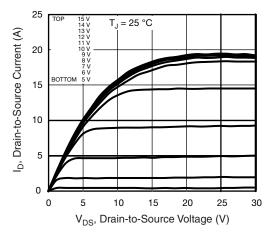


Fig. 1 - Typical Output Characteristics

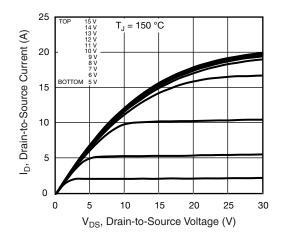


Fig. 2 - Typical Output Characteristics

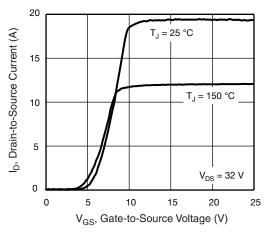


Fig. 3 - Typical Transfer Characteristics

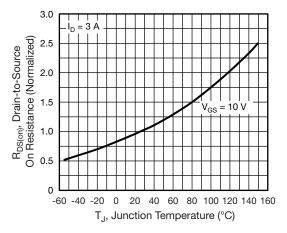


Fig. 4 - Normalized On-Resistance vs. Temperature

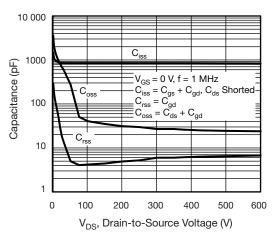


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

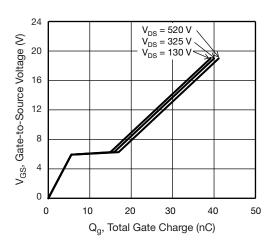


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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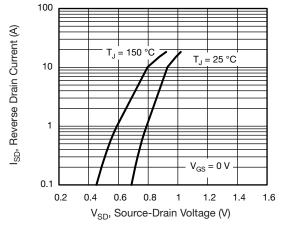


Fig. 7 - Typical Source-Drain Diode Forward Voltage

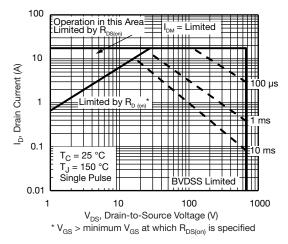


Fig. 8 - Maximum Safe Operating Area

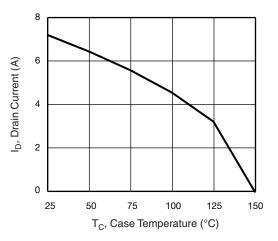


Fig. 9 - Maximum Drain Current vs. Case Temperature

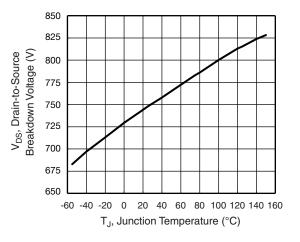
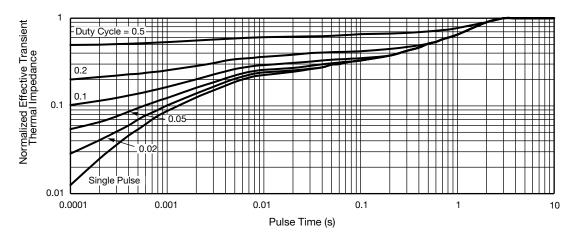
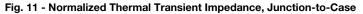


Fig. 10 - Temperature vs. Drain-to-Source Voltage





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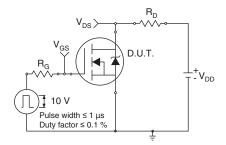


Fig. 12 - Switching Time Test Circuit

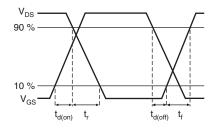


Fig. 13 - Switching Time Waveforms

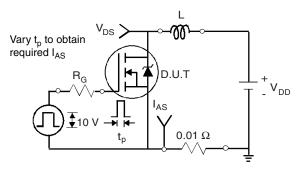


Fig. 14 - Unclamped Inductive Test Circuit

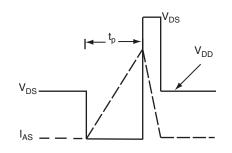


Fig. 15 - Unclamped Inductive Waveforms

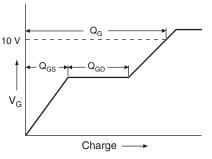


Fig. 16 - Basic Gate Charge Waveform

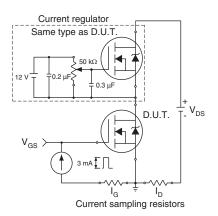


Fig. 17 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit

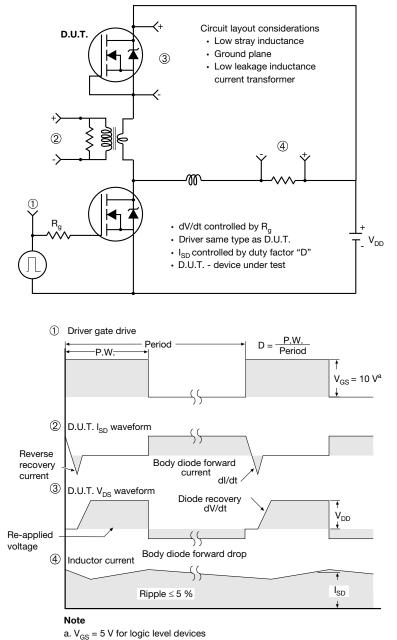


Fig. 18 - For N-Channel

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